

**Method and device for spacing apart electronic components arranged
in a matrix structure**

Abstract

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The invention relates to a method for spacing apart electronic components arranged in a matrix structure, comprising the processing steps of: A) picking up a part of a group of electronic components arranged in an initial matrix structure; and B) setting down the picked-up electronic components on a carrier. The invention also relates to a device for

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spacing apart electronic components arranged in a matrix structure.

[Figure 2]